



Click [here](#) for the 3D model.

Dimensions

Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
T	1.25mm +/-0.15mm
S	0.75mm MIN
B	0.5mm +/-0.25mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

General Information

Series	SMD COTS COG
Style	SMD Chip
Description	SMD, MLCC, COTS, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
Failure Rate	Testing per MIL-PRF-55681 PDA 8%, DPA per EIA-469
AEC-Q200	No
Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.047 uF
Measurement Condition	1kHz 1.0Vrms
Capacitance Tolerance	1%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	21.2766 GOhms